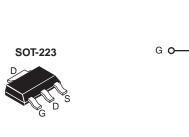


### **CET4401B-VB** Datasheet

P-Channel 35 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)	
- 35	0.040 at $V_{GS}$ = - 10 V	- 6.2	9.8 nC	
- 55	0.048 at V <sub>GS</sub> = - 4.5 V	- 5.1	9.0110	



P-Channel MOSFET

D

S

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % Rg Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- · Load Switches, Adaptor Switch
  - Notebook PCs

Pb-free
RoHS

COMPLIANT HALOGEN FREE

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 35	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 6.2		
	T <sub>C</sub> = 70 °C	1 . [	- 4.8		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.5 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 3.4 <sup>a, b</sup>	,	
Pulsed Drain Current		I <sub>DM</sub>	- 20	A	
	T <sub>C</sub> = 25 °C		- 3.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>		
Avalanche Current		I <sub>AS</sub>	- 10		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
	T <sub>C</sub> = 25 °C		4.2		
	T <sub>C</sub> = 70 °C		2.7		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	24	30	0/10

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 85 °C/W.

d. Based on  $T_C = 25 \ ^{\circ}C$ .

<b>SPECIFICATIONS</b> (T <sub>1</sub> = 25 °C, unless otherwise noted)								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static				<u> </u>		I		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 35			V		
$\label{eq:VDS} \begin{array}{ll} V_{DS} \mbox{ Temperature Coefficient} & \Delta V_{DS}/T_J \\ V_{GS(th)} \mbox{ Temperature Coefficient} & \Delta V_{GS(th)}/T_J \end{array}$		L 050		- 42		mV/°C		
		I <sub>D</sub> = - 250 μA		4.6				
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.6		- 1.8	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA		
	I <sub>DSS</sub>	V <sub>DS</sub> = - 35 V, V <sub>GS</sub> = 0 V			- 1			
Zero Gate Voltage Drain Current		$V_{DS}$ = - 35 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 5	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 10 V, $V_{GS}$ = - 10 V	- 10			A		
	Р	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		0.040				
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4 A		0.048		Ω		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 5 A		14		S		
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			970		pF		
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, f = 1 MHz		120				
Reverse Transfer Capacitance	C <sub>rss</sub>			95				
Total Gate Charge	Qg	$V_{DS}$ = - 20 V, $V_{GS}$ = - 10 V, $I_D$ = - 5 A		23	35	35		
Iotal Gate Charge				9.8	16	nC		
Gate-Source Charge	Q <sub>gs</sub>	$V_{\rm DS} = -20$ V, $V_{\rm GS} = -4.5$ V, $I_{\rm D} = -5$ A		3				
Gate-Drain Charge	Q <sub>gd</sub>			5.2				
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.0	5.5	11	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			7	14			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 4 $\Omega$		12	24			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		30	60			
Fall Time	t <sub>f</sub>			9	18	200		
Turn-On Delay Time	t <sub>d(on)</sub>			44	80	- ns -		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 4 $\Omega$		33	60			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_{D}\cong$ - 5 A, $V_{GEN}$ = - 4.5 V, $R_{g}$ = 1 $\Omega$		28	55			
Fall Time	t <sub>f</sub>			13	25			
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 3.5	A		
Pulse Diode Forward Current	I <sub>SM</sub>				- 20			
Body Diode Voltage	$V_{SD}$	$I_{S} = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.76	- 1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			27	50	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		19	35	nC		
Reverse Recovery Fall Time	ta	$\mu_{\rm F} = -2$ A, $\alpha_{\rm F}\alpha_{\rm C} = 100$ A/ $\mu_{\rm S}$ , $1J = 25$ C		14		ns		
Reverse Recovery Rise Time	t <sub>b</sub>			13		115		
Notes:								

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

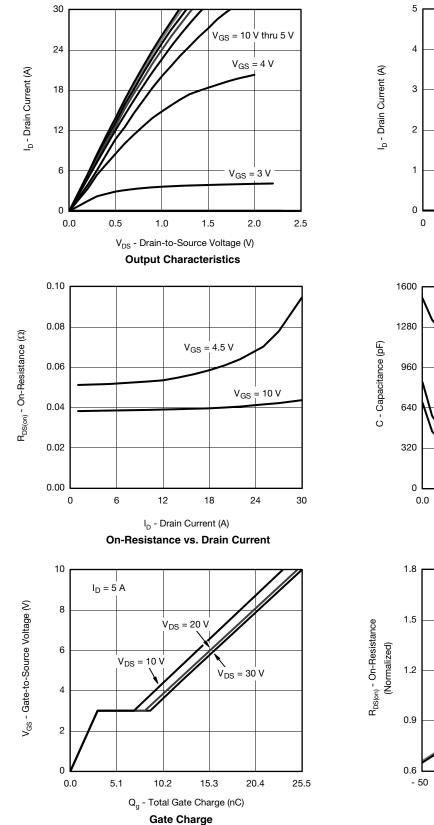
b. Guaranteed by design, not subject to production testing.

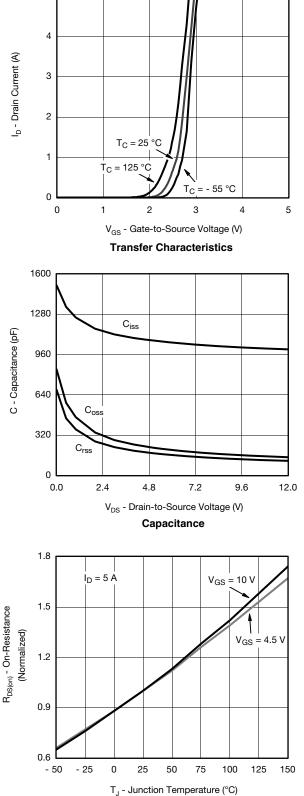
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi

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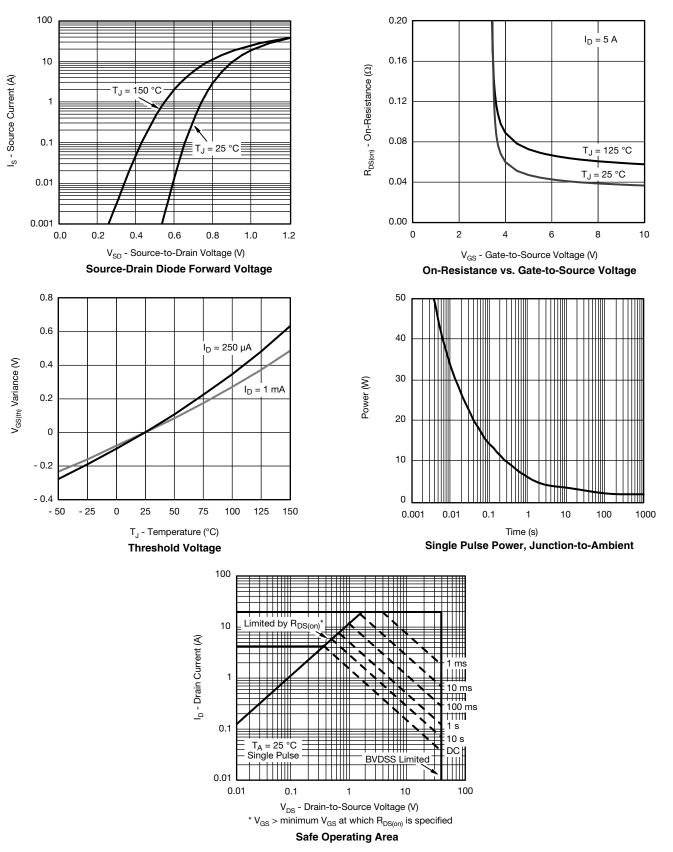




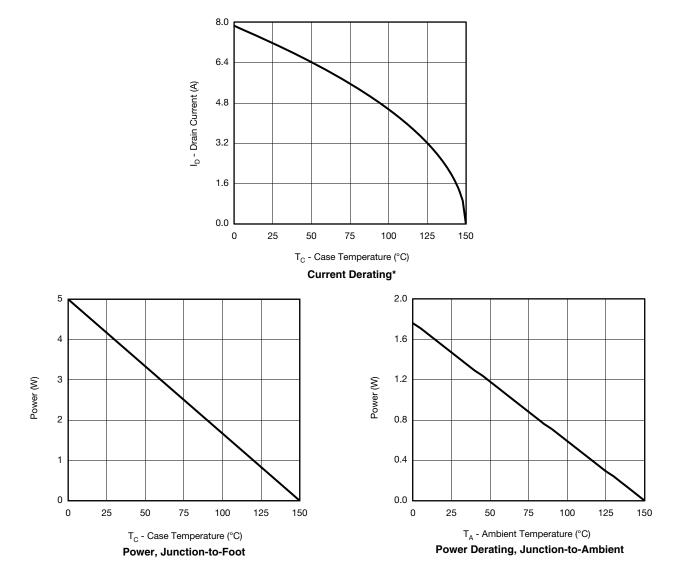


**On-Resistance vs. Junction Temperature** 



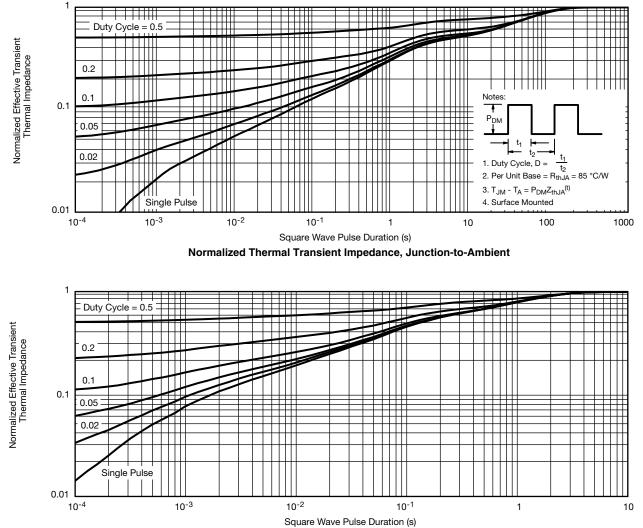






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

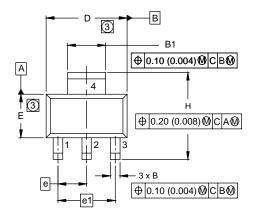


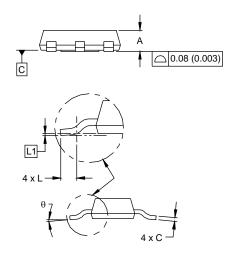


Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60 BSC		0.181 BSC		
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.061 BSC		0.002	4 BSC	
θ	-	10'	-	10'	

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension do not include mold flash.

4. Outline conforms to JEDEC outline TO-261AA.



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